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52382 10/10/00 PATENT	
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
1. Name of conveying party(ies)/Execution Date(s):	2. Name and address of receiving party(ies)
Sung-Hyun LIM	Name: Samsung Electronics Co., Ltd. 9081
	200
Execution Date(s) October 18, 2006	Street Address: 416, Maetan-dong, Yeongtong-gu
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	
9. Nature of conveyance:	City: Suwon-si
	State: Gyeonggi-do
<ul><li>☐ Security Agreement</li><li>☐ Change of Name</li><li>☐ Government Interest Assignment</li></ul>	Country: Republic of Korea Zip: 442-742
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Other	Additional name(s) & address(es) attached? 🗌 Yes 🖾 No
4. Application or patent number(s):	his document is being filed together with a new application.
A. Patent Application No.(s)	B. Patent No.(s)
Additional numbers attached? ☐ Yes ☒ No	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Roylance, Abrams, Berdo & Goodman, L.L.P.	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Suite 600	☐ Authorized to be charged by credit card
	Authorized to be charged to deposit account
Street Address: 1300 19 <sup>th</sup> Street, NW	⊠ Enclosed
	☐ None required (government interest not affecting title)
City: Washington	8. Payment Information
State: D.C. Zip: 20036	a. Credit Card Last 4 Numbers
Phone Number: (202) 659-9076	Expiration Date
Fax Number: (202) 659-9344	b. Deposit Account Number18-2220
Email Address:	Authorized User NameJohn E. Holmes
9. Signature:	October 18, 2006
Signature	October 18, 2006 Date

Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

10/19/2006 SDEMBOB1 00000036 11582489 40.00 DP 01 FC:8021

Our File No: 52382 Your File No: SH-26132-US

## ASSIGNMENT

WHEREAS, I, Sung-Hyun LIM, a citizen of the Republic of Korea, residing at 401 (1009-8) Sadang 1-dong, Dongjak-gu, Seoul, Republic of Korea (hereinafter "ASSIGNOR"), have made a certain invention entitled "IMAGE PROCESSING APPARATUS AND METHOD" for which I am making application for Letters Patent of the United States, which application is being executed concurrently herewith; and

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter "ASSIGNEE"), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all United States Letters Patent to be obtained on said invention and/or application;

## NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to me by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in the United States; and our right to file said applications and claim priority under the provisions of any international treaty or convention; and in and to any Letters Patent of the United States issued or granted on said invention and/or said applications;

AND I HEREBY authorize and request the U.S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said applications to said ASSIGNEE as sole assignee;

AND I HEREBY covenant that I have the full right to convey the entire right, title and interest herein assigned and that I have not executed and will not execute any assignment or other instrument in conflict herewith;

AND I HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal

**A88IGNMENT** 

PATENT REEL: 018437 FRAME: 0352 representatives or assigns to obtain and enforce proper patent protection on and for said invention in the United States, and likewise I make these provisions binding upon our heirs, legal representatives and/or administrators.

I hereby grant the firm of Roylance, Abrams, Berdo & Goodman, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, I have hereunder set my hand and sent this leth day of October , 2006.

Sung-Hyun LIM

Sung-Hyun LIM

Witness

ASBIGNMENT

2

PATENT REEL: 018437 FRAME: 0353

**RECORDED: 10/18/2006**